# ® SHENZHEN LONG JING MICRO-ELECTRONICS CO., LTD. TO-220 Plastic-Encapsulate Thyristors 

## ALJCT610 <br> 10A Silicon Controlled Rectifier

## Description

ALJCT610 series of silicon controlled rectifiers, with high ability to withstand the shock loading of large current, provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.

ALJCT610A provides insulation voltage rated at 2500 V RMS and ALJCT610F provides insulation voltage rated at 2000V RMS from all three terminals to external heatsink.


Maximum Ratings ( $\mathrm{T}_{\mathrm{j}}=\mathbf{2 5 ^ { \circ }} \mathrm{C}$ unless otherwise noted)

| Symbol | Parameter | Value | Unit |
| :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {(RMS }}$ | RMS on-state current | 10 | A |
| Itsm | Non repetitive surge peak on-state current $\left(\mathrm{t}_{\mathrm{p}}=10 \mathrm{~ms}\right)$ | 120 | A |
| V ${ }_{\text {dRM }}$ | Repetitive peak off-state voltage | 500 | V |
| VRRM | Repetitive peak reverse voltage | 500 | V |
| $\mathrm{I}^{2} \mathrm{t}$ | $I^{2} \mathrm{t}$ value for fusing (tp=10ms) | 72 | $A^{2} \mathrm{~s}$ |
| dl/dt | Critical rate of rise of on-state current( $\mathrm{IG}_{\mathrm{G}}=2 \times \mathrm{IGT}^{\text {) }}$ | 50 | $\mathrm{A} / \mu \mathrm{s}$ |
| IGm | Peak gate current | 4 | A |
| $\mathrm{PG}_{\mathrm{g}}(\mathrm{AV})$ | Average gate power dissipation | 1 | W |
| PGm | Peak gate power | 5 | W |
| T ${ }^{\text {j }}$ | Junction Temperature | -40~125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature | -40~150 | ${ }^{\circ} \mathrm{C}$ |

## Thermal Resistances

| Symbol | Parameter | Value | Unit |
| :--- | :--- | :---: | :---: |
| R $_{\text {өJc }}$ | junction to case | 4.8 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Electrical Characteristics ( $\mathrm{T}_{\mathrm{j}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ unless otherwise specified)

| Symbol | Test Conditions |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Igt | $V_{D}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=33 \Omega$ |  |  |  | 10 | mA |
| $V_{G T}$ |  |  |  |  | 1.5 | V |
| $\mathbf{V G D}^{\text {g }}$ | $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{DRM}}, \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=3.3 \mathrm{~K} \Omega$ |  | 0.2 |  |  | V |
| IL | $\mathrm{IG}_{\mathrm{G}}=1.2 \mathrm{I}_{\mathrm{GT}}$ |  |  |  | 25 | mA |
| $\mathrm{IH}_{\mathrm{H}}$ | $\mathrm{I}_{\mathrm{T}}=500 \mathrm{~mA}$ |  |  |  | 15 | mA |
| dV/dt | $\mathrm{V}_{\mathrm{D}}=2 / 3 \mathrm{~V}_{\text {DRM }}$, Gate Open $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  | 50 |  |  | $\mathrm{V} / \mu \mathrm{s}$ |
| $V_{\text {TM }}$ | $\mathrm{I}_{\text {TM }}=20 \mathrm{~A}, \mathrm{tp}=380 \mu \mathrm{~s}$ |  |  |  | 1.55 | V |
| IDRM | $\begin{aligned} & V_{D}=V_{D R M} \\ & V_{R}=V_{R R M} \end{aligned}$ | $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ |  |  | 5 | $\mu \mathrm{A}$ |
| IRRM |  | $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ |  |  | 1 | mA |

## Typical Characteristics

FIG. 1 Maximum power dissipation versus RMS on-state current


FIG.3: Surge peak on-state current versus number of cycles


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $\mathrm{tp}<10 \mathrm{~ms}$, and corresponging value of $\mathrm{l}^{2} \mathrm{t}(\mathrm{dl} / \mathrm{dt}<50 \mathrm{~A} / \mu \mathrm{s}$ )


FIG.2: RMS on-state current versus case temperature
IT(RMS) (A)


FIG.4: On-state characteristics (maximum values)
Itm (A)


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature


